



Material Content Data Sheet



Sales Product Name		SPA06N60C3		Issued		26. September 2017		
MA#		MA001507252						
Package		PG-TO220-3-317		Weight*		2106.64 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.096	0.19	0.19	1944	1944
leadframe	non noble metal	iron	7439-89-6	1.202	0.06		571	
	inorganic material	phosphorus	7723-14-0	0.361	0.02		171	
	non noble metal	copper	7440-50-8	1200.685	56.99	57.07	569952	570694
wire	non noble metal	aluminium	7429-90-5	8.118	0.39	0.39	3854	3854
encapsulation	organic material	carbon black	1333-86-4	8.818	0.42		4186	
	plastics	epoxy resin	-	141.095	6.70		66976	
	inorganic material	silicondioxide	60676-86-0	731.929	34.74	41.86	347438	418600
leadfinish	non noble metal	tin	7440-31-5	7.889	0.37	0.37	3745	3745
solder	non noble metal	antimony	7440-36-0	0.245	0.01		116	
	noble metal	silver	7440-22-4	0.613	0.03		291	
	non noble metal	tin	7440-31-5	1.593	0.08	0.12	756	1163
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com